# IC51 Series (Clamshell)

# Small Outline Package (SOP)

### **Specifications**

Insulation Resistance: 1,000M $\Omega$  min. at 500V DC Dielectric Withstanding Voltage: 700V AC for 1 minute

Contact Resistance:  $30m\Omega$  max. at 10mA/20mV max. Operating Temperature Range: -40°C to +150°C (type PSF)

-55°C to +170°C (type PES & PEI)

Mating Cycles: 10,000 insertions min.

#### **Materials and Finish**

Housing: Polysulphone (PSF), glass-filled

Polyethersulphone (PES), glass-filled Polyetherimide (PEI), glass-filled

Contacts: Beryllium Copper (BeCu)

Plating: Gold over Nickel

### Part Number (Details)

IC51 - 008 2 - 1024 - MF

Series No.

No. of Contact Pins

No. of Sides with Contacts

Design Number

MF= Flanged

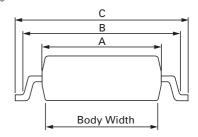
Unmarked = Not Flanged

### Applicable Dimensions (Reference Only)

### Example of a SOP Socket

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#### **Outline IC Dimensions**



A = Body width (max.)

B = Also the lid size for IC

C = Tip-to-Tip

F = Lid size from Socket

### **SOP Clamshell**

Part Number	Pin Count	Pitch	Matching IC Dim.				Note	Socket Dimensions		
			Body Width	A (max)	B (max)	C(nom.)	Note	D	Е	F
IC51-0082-1024	8	1.27	5.2	5.25	7.2	7.9	FB	18.5	32.5	7.2
IC51-1035.KS-10460	8	1.27	4.0	4.0	5.4	6.0	S	22.0	27.2	5.4
IC51-0122-1836	12	0.80	4.4	4.4	5.9	6.4	S	14.0	32.4	5.9
IC51-0142-951	14	1.25	4.4	4.5	5.2	5.9	S	24.0	27.5	5.2
IC51-0142-084	14	1.27	4.4	4.5	5.7	6.5	S	22.0	25.0	5.7
IC51-0142-1013	14	1.27	5.2	5.25	7.2	7.9	FB	18.5	32.5	7.2
IC51-1035.KS-15187	14	1.27	4.0	4.0	5.4	6.0	S	22.0	27.2	5.4
IC51-0162-1035	16	1.27	4.0	4.0	5.4	6.0	S	22.0	27.2	5.4
IC51-0162-1042	16	1.27	4.0	4.2	5.4	6.2	S	22.0	27.2	5.4
IC51-0162-658	16	1.27	4.4	4.5	6.2	7.0	S	26.0	31.5	5.7
IC51-0162-271-3	16	1.27	4.4	5.0	5.2	6.0	S	13.0	26.5	5.22
IC51-0162-271-2	16	1.27	5.0	5.0	5.2	6.0	S	13.0	26.5	5.22
IC51-0162-271-1	16	1.27	5.5	5.0	5.2	6.0	S	13.0	26.5	5.22
IC51-0162-272-1	16	1.27	5.5	5.5	5.7	6.5	S	13.0	26.5	5.72
IC51-0162-273-1	16	1.27	5.5	5.5	6.22	7.0	S	13.0	26.5	6.22
IC51-0162-1025	16	1.27	5.2	5.25	7.2	7.9	FB	18.5	32.5	7.2
IC51-0162-902-2	16	1.27	5.3	5.35	7.2	8.2	S	12.0	28.5	7.2
IC51-347.KS-7704	16	1.27	7.7	7.7	9.5	10.3	S	16.0	31.5	9.53
IC51-347.KS-6768	18	1.27	7.7	7.7	9.5	10.3	S	16.0	31.5	9.53
IC51334.KS-13574	20	1.27	7.5	7.6	9.4	10.3	S	18.0	32.0	9.3

Note:

Sockets with ( **S** ) "Separator" can accept and properly align lower pin count devices.

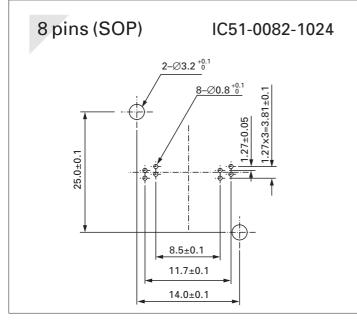
Sockets with ( **FB**) "Floating Base" will only accept devices with the same pin count as the socket.

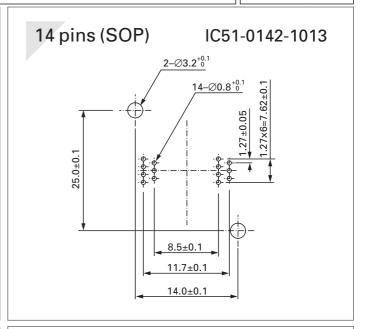
# IC51 - Clamshell

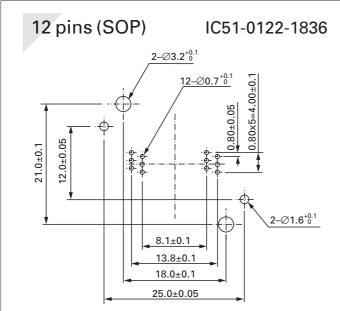
# Small Outline Package (SOP)

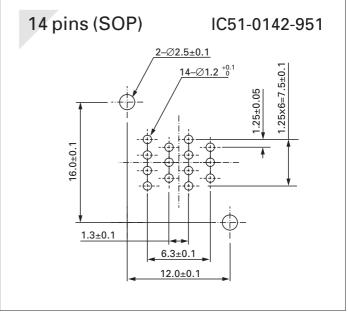
# Socket & PCB Orientation Top View from 28 - 88 Socket 888 - 88

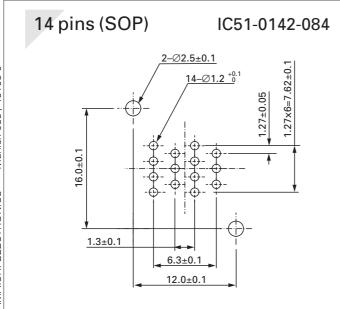
# Recommended PCB Layouts (8-14 pins)

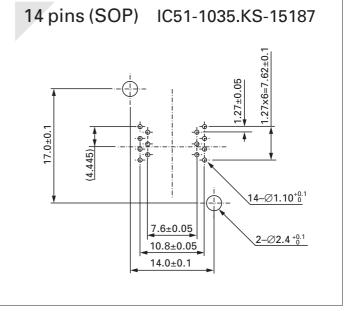












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# IC51 - Clamshell

# Small Outline Package (SOP)

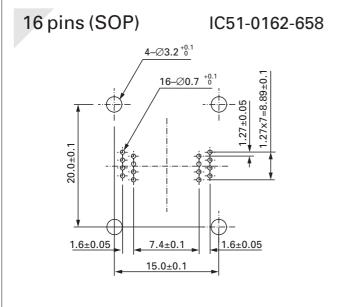
 $20.0\pm0.15$ 

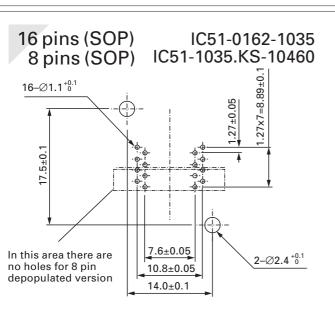
1.8±0.05

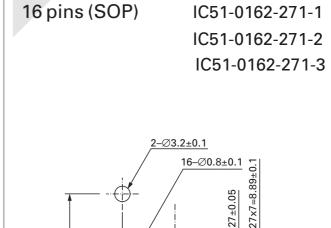
# Socket & PCB Orientation Top View from Socket

IC51-0162-271-1

### Recommended PCB Layouts (8-16 pins)

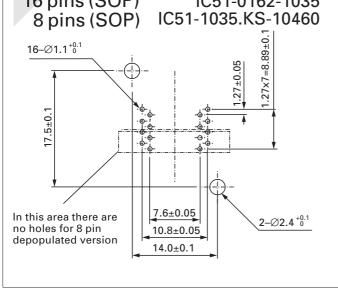


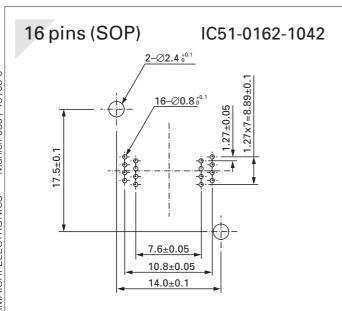


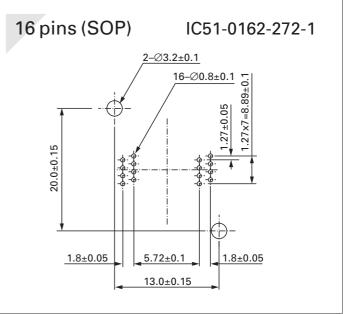


5.72±0.1

13.0±0.15







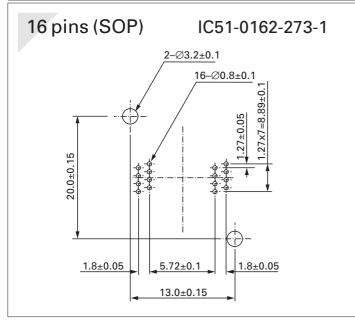
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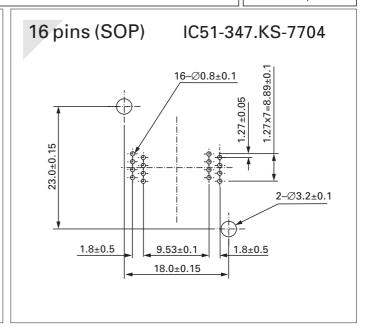
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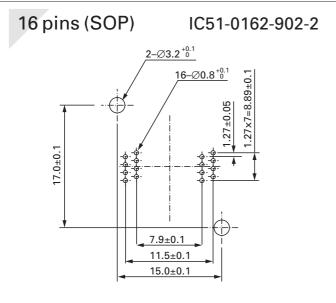
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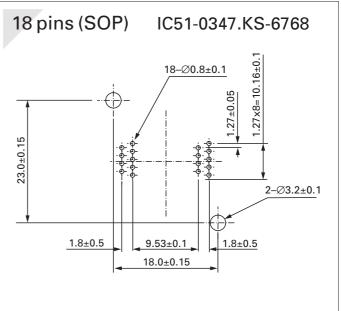
# Socket & PCB Open Orientation Top View from 28 - 88 Socket 88

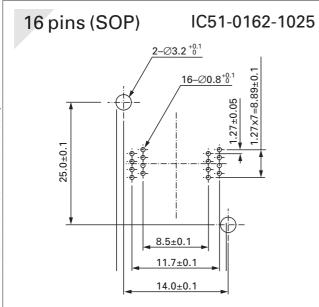
# Recommended PCB Layouts (16-20 pins)

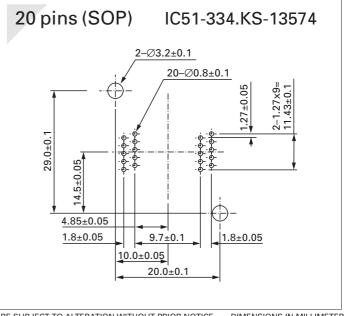












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